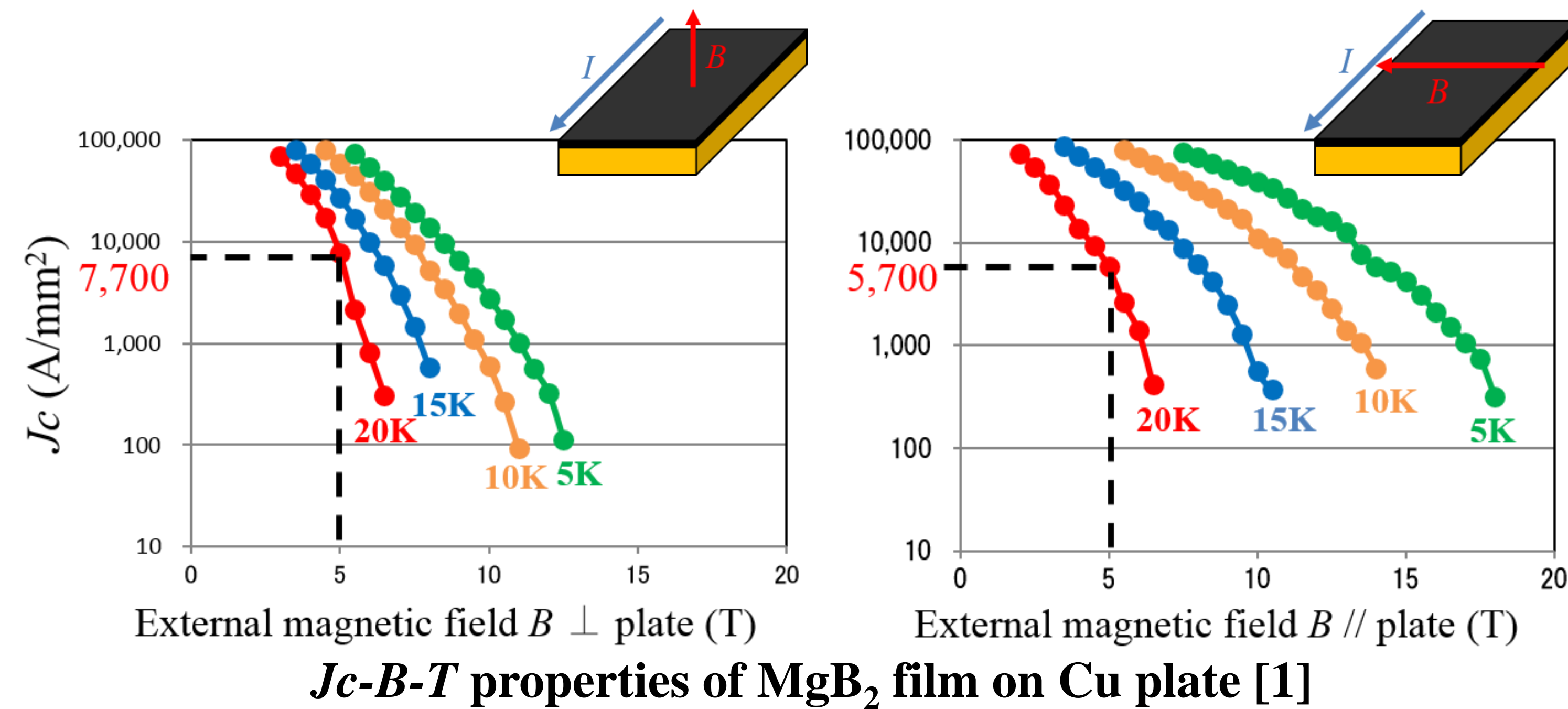


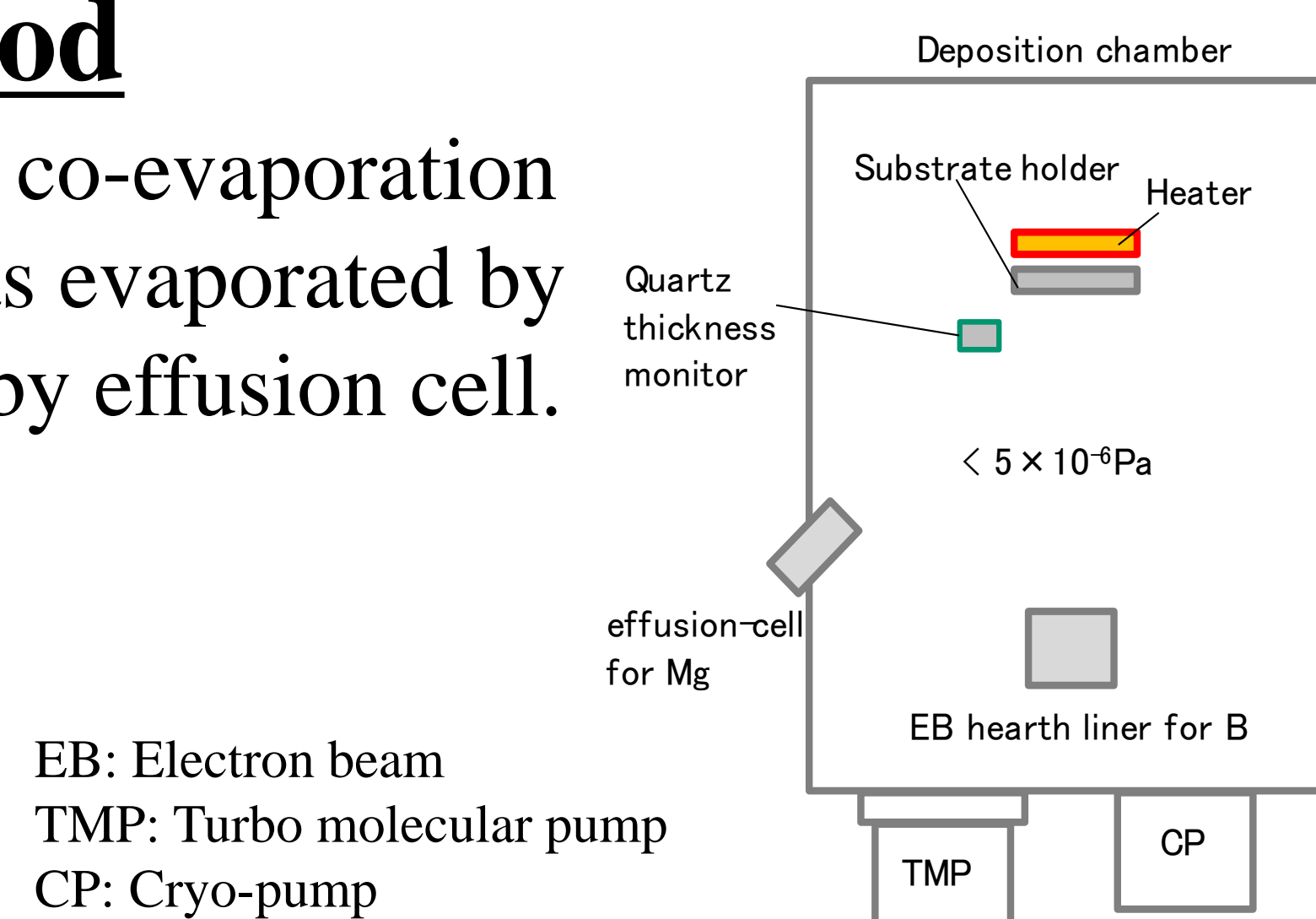
## 1. Motivation

Last year, we reported MgB<sub>2</sub> film deposited on 500 μm-thick Cu plate [1]. The superior *J<sub>c</sub>*-*B*-*T* properties of the film suggested that thin film MgB<sub>2</sub> will be advantageous for superconductor tape and coil applications under high magnetic field. The next step is depositing MgB<sub>2</sub> film on thin Cu tape to increase the engineering critical current density *Je*. We deposited MgB<sub>2</sub> film on 40 μm-thick Cu tape and measured *T<sub>c</sub>*, *J<sub>c</sub>*-*B*-*T* and *Je*-*B*-*T* properties.

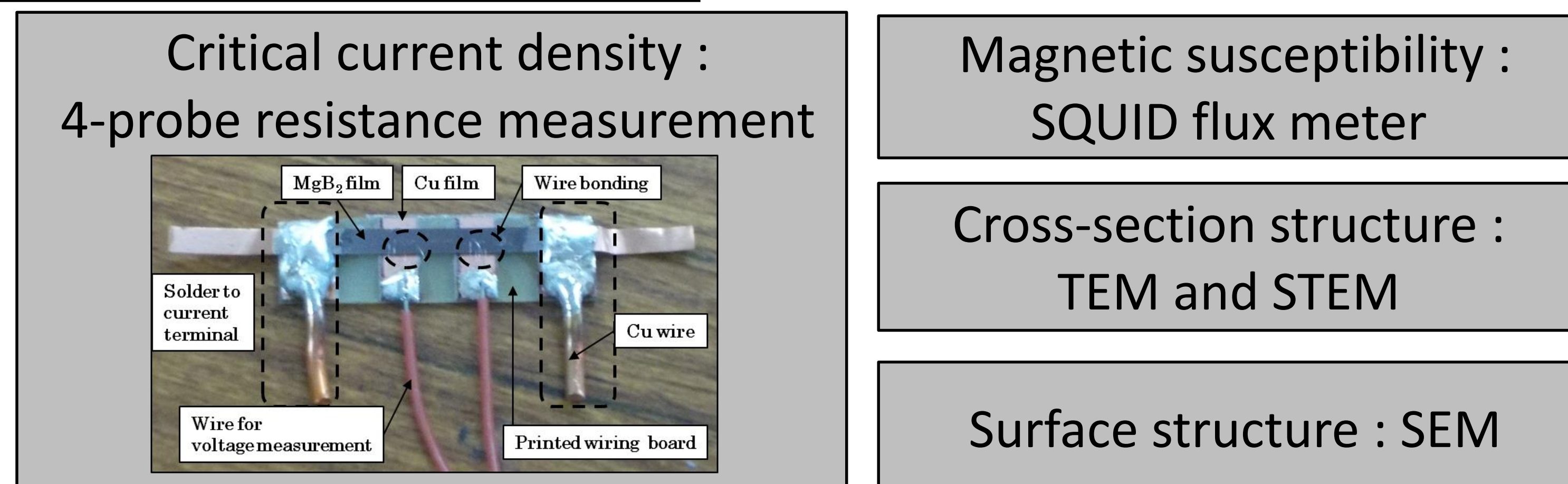


## 2. Experimental method

MgB<sub>2</sub> films were deposited by co-evaporation of boron and magnesium. B was evaporated by EB, while Mg was evaporated by effusion cell.

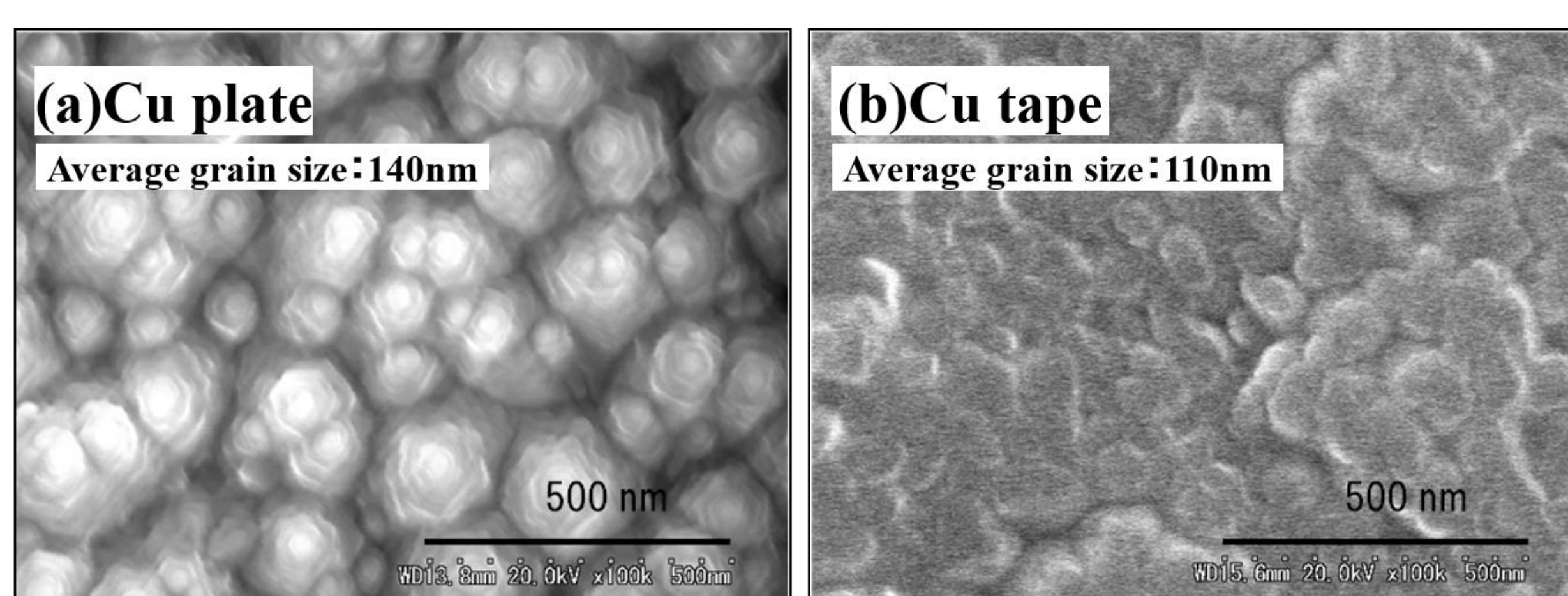
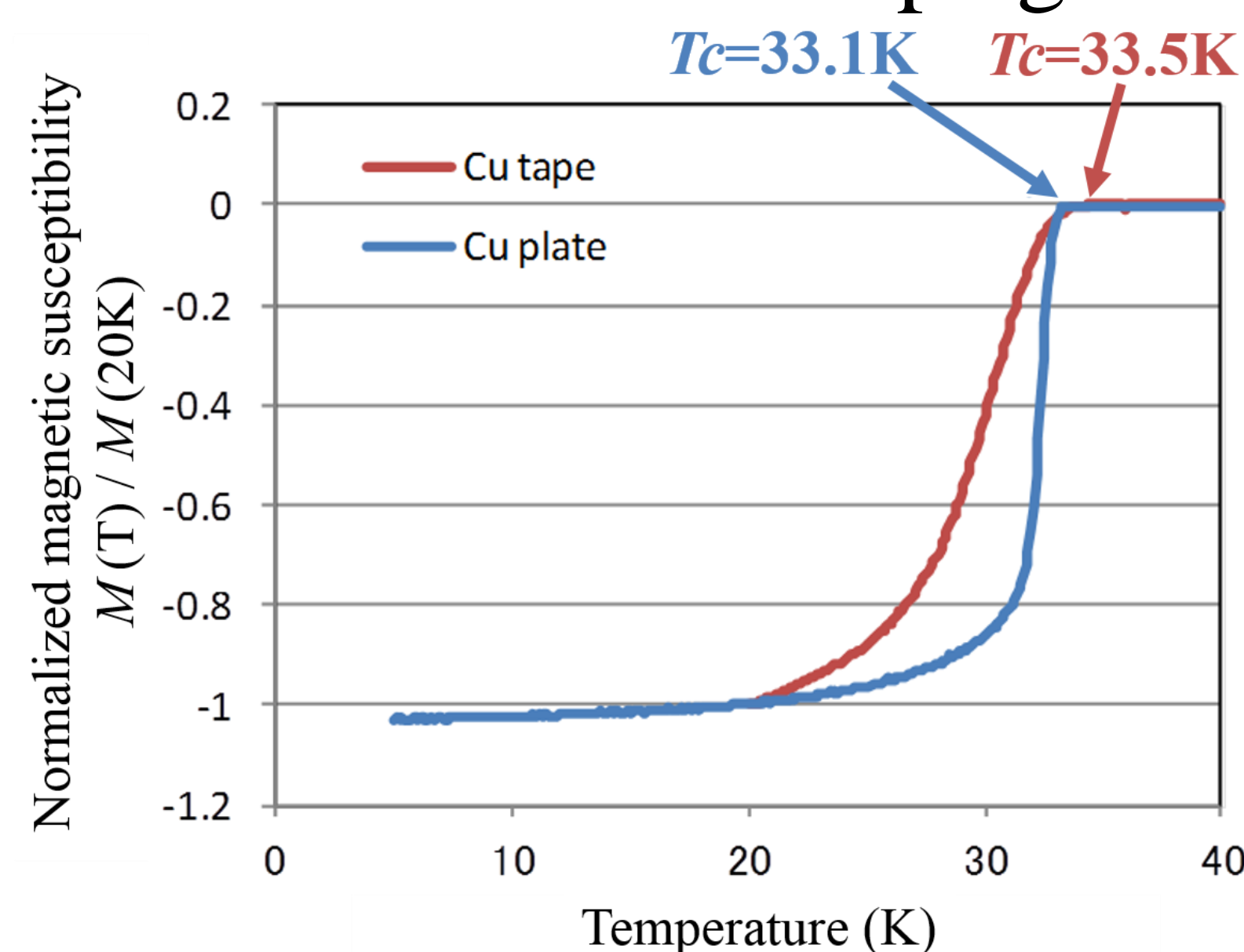


## 3. Evaluation method



## 4. Results

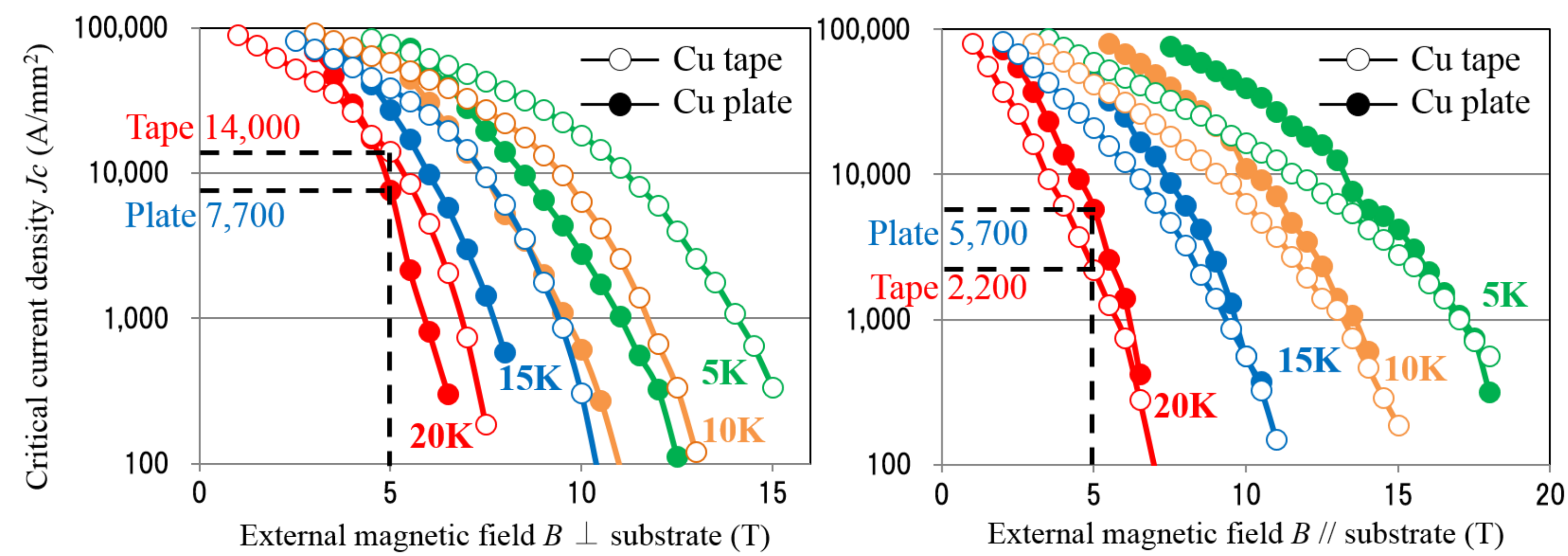
- *T<sub>c</sub>* of MgB<sub>2</sub> film was almost same on Cu tape and plate. Crystal orientation of film on tape got worse than plate.



**Fig.2 Surface SEM images of MgB<sub>2</sub> films on (a)Cu plate and (b)Cu tape**

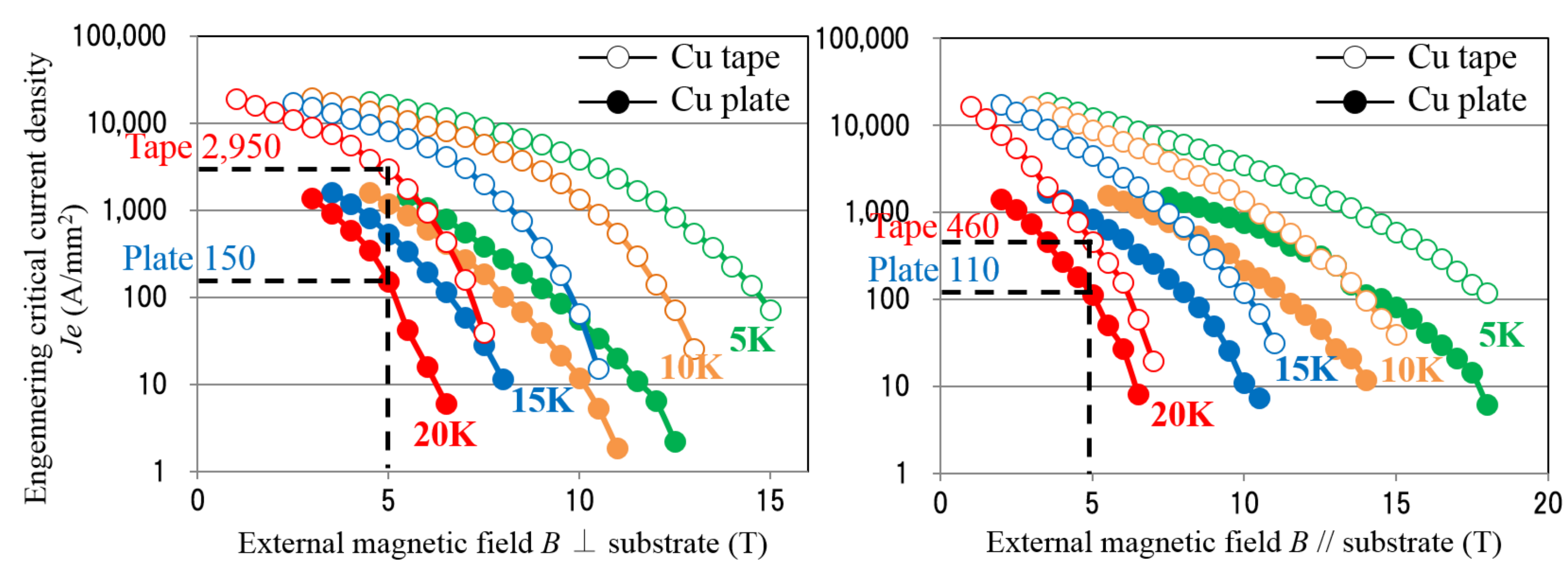
## ■ *J<sub>c</sub>* of films on Cu plate and tape

- *B* ⊥ substrate plate : 7,700 → tape : 1,4000 A/mm<sup>2</sup> @ 20 K, 5 T
- *B* // substrate plate : 5,700 → tape : 2,200 A/mm<sup>2</sup> @ 20 K, 5 T

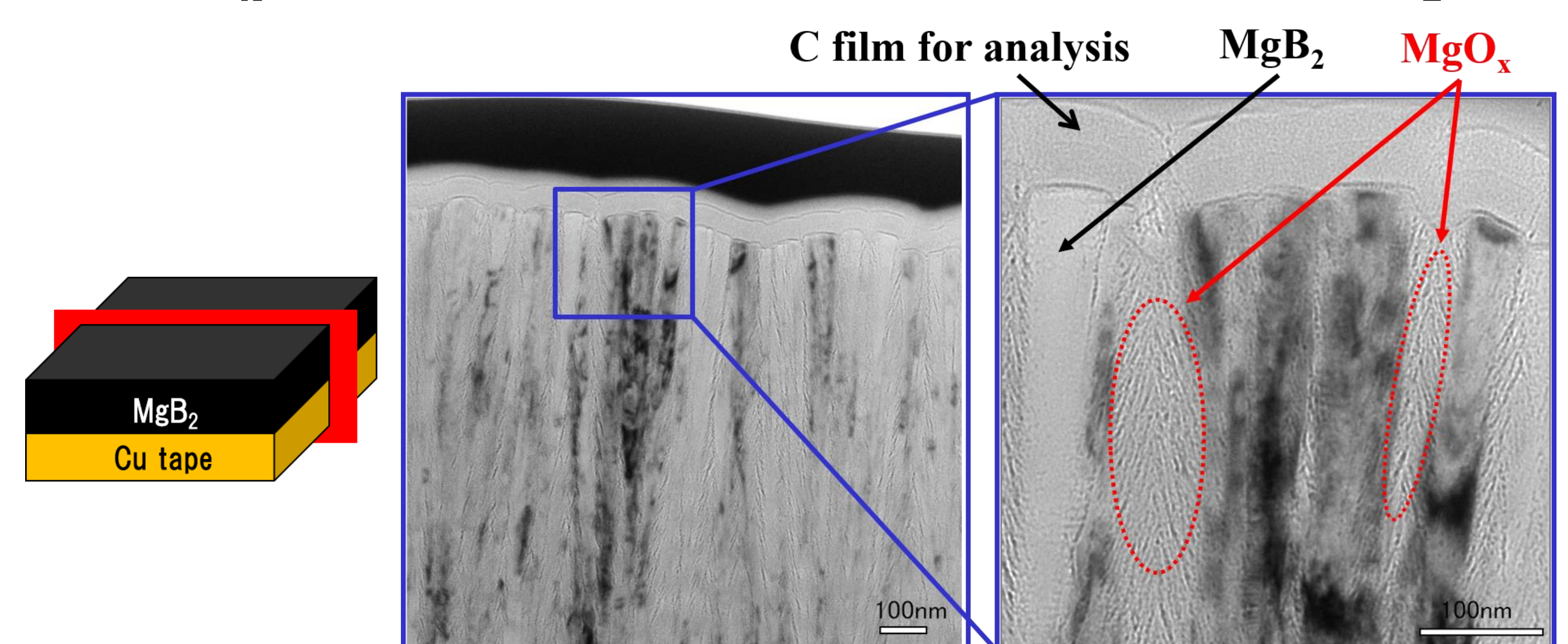


## ■ *Je* of films on Cu plate and tape

- The thickness of substrate plate : 500 μm → tape : 40 μm
- *B* ⊥ substrate plate : 150 → tape : 2,950 A/mm<sup>2</sup> @ 20 K, 5 T
- *B* // substrate plate : 110 → tape : 460 A/mm<sup>2</sup> @ 20 K, 5 T

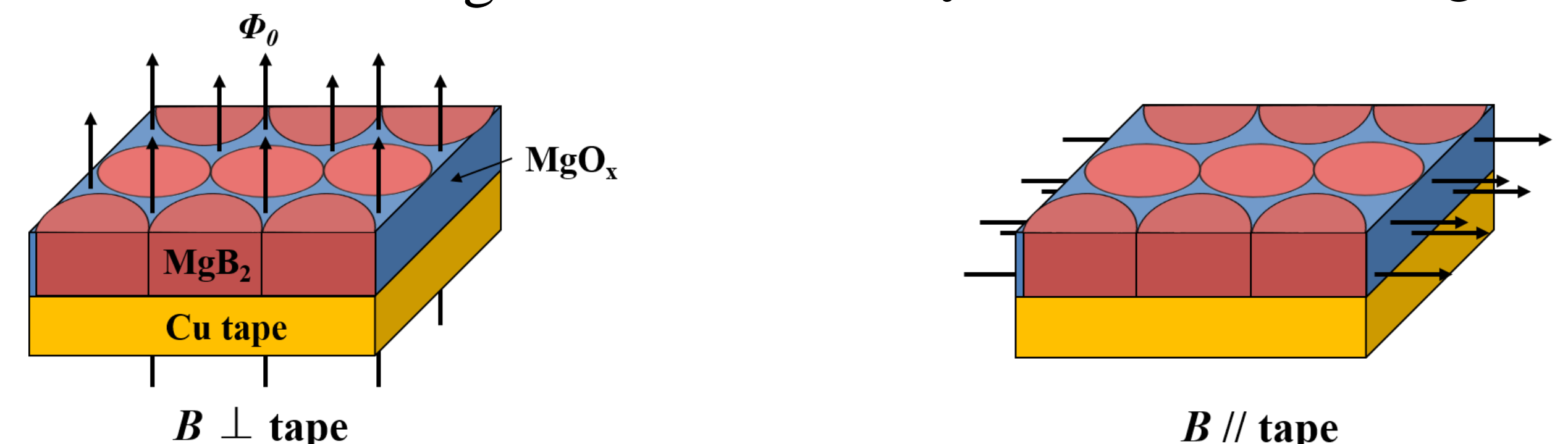


## ■ MgO<sub>x</sub> are distributed at grain boundaries of MgB<sub>2</sub>



## ■ Cause of *J<sub>c</sub>* change

- *B* ⊥ substrate : *J<sub>c</sub>* improved  
pinning force improvement  
> crystal orientation degradation
- *B* ⊥ substrate : *J<sub>c</sub>* degraded  
pinning force improvement  
< crystal orientation degradation



## 5. Conclusions

We deposited MgB<sub>2</sub> film on thin Cu tape and measured *T<sub>c</sub>*, *J<sub>c</sub>*-*B*-*T* and *Je*-*B*-*T* properties.

- (1) *T<sub>c</sub>* of film on tape was 33.5 K, equivalent to that of film on plate .
- (2) *Je* at 20 K, *B*=5 T was 2,950A/mm<sup>2</sup> in the *B* ⊥ substrate direction and 460 A/mm<sup>2</sup> in the *B* // substrate direction.
- (3) *J<sub>c</sub>* of film on tape at 20 K, 5 T improved in *B* ⊥ substrate direction and degraded in *B* // substrate direction than that of film on plate due to existence of MgO<sub>x</sub>.

## 6. References

- [1] T. Kusunoki, et al. ASC 2016, 3MPo2B-10 (Sep.2016 , Denver, USA)